

$V_{RM} = 2000\text{ V}$ ,  $I_{F(AV)} = 0.1\text{ A}$ ,  $t_{rr} = 100\text{ ns}$   
**Fast Recovery Diode**  
**RP1H**

**Description**

The RP1H is a high voltage fast recovery diode of 2000 V / 0.1 A. The maximum  $t_{rr}$  of 100 ns is realized by optimizing a life-time control.

**Features**

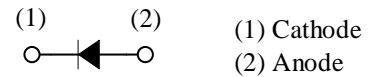
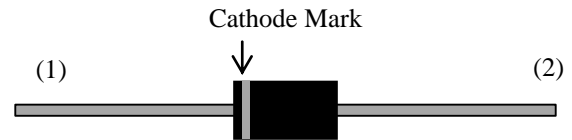
- $V_{RM}$ -----2000 V
- $I_{F(AV)}$ -----0.1 A
- $V_F$ -----7.0 V
- $t_{rr1}$ -----100 ns
- Bare Leads: Pb-free (RoHS Compliant)

**Applications**

- Sunuber Diode  
(Flyback Converter, etc.)

**Package**

Axial ( $\phi 4 \times 7.2L / \phi 0.78$ )



Not to scale

# RP1H

## Absolute Maximum Ratings

Unless otherwise specified,  $T_A = 25\text{ }^\circ\text{C}$

Parameter	Symbol	Rating	Unit	Conditions
Peak Repetitive Reverse Voltage	$V_{RSM}$	2000	V	
Repetitive Reverse Voltage	$V_{RM}$	2000	V	
Average Forward Current	$I_{F(AV)}$	0.1	A	See Figure 2 and Figure 3
Surge Forward Current	$I_{FSM}$	5	A	Half cycle sine wave, positive side, 10 ms, 1 shot
$I^2t$ Limiting Value	$I^2t$	0.125	$A^2s$	$1\text{ ms} \leq t \leq 10\text{ ms}$
Junction Temperature	$T_J$	-40 to 150	$^\circ\text{C}$	
Storage Temperature	$T_{STG}$	-40 to 150	$^\circ\text{C}$	

## Electrical Characteristics

Unless otherwise specified,  $T_A = 25\text{ }^\circ\text{C}$

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage Drop	$V_F$	$T_J = 25\text{ }^\circ\text{C}, I_F = 0.1\text{ A}$	—	—	7.0	V
		$T_J = 100\text{ }^\circ\text{C}, I_F = 0.1\text{ A}$	—	2.0	—	V
Reverse Leakage Current	$I_R$	$V_R = V_{RM}$	—	—	2	$\mu\text{A}$
Reverse Leakage Current Under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 100\text{ }^\circ\text{C}$	—	—	10	$\mu\text{A}$
Reverse Recovery Time	$t_{rr1}$	$I_F = I_{RP} = 100\text{ mA}$ 90% recovery point, $T_J = 25\text{ }^\circ\text{C}$	—	—	100	ns
	$t_{rr2}$	$I_F = 100\text{ mA},$ $I_{RP} = 200\text{ mA},$ 75% recovery point, $T_J = 25\text{ }^\circ\text{C}$	—	—	50	ns
Thermal Resistance <sup>(1)</sup>	$R_{th(J-L)}$	See Figure 1	—	—	15	$^\circ\text{C/W}$

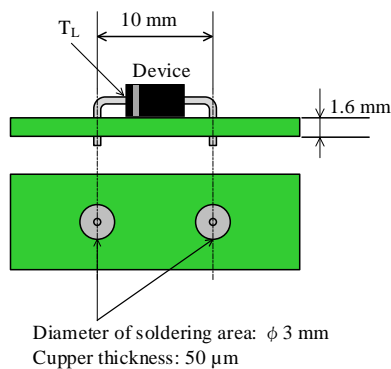


Figure 1 Lead Temperature Measurement Conditions

<sup>(1)</sup>  $R_{th(J-L)}$  is thermal resistance between junction and lead.

Rating and Characteristic Curves

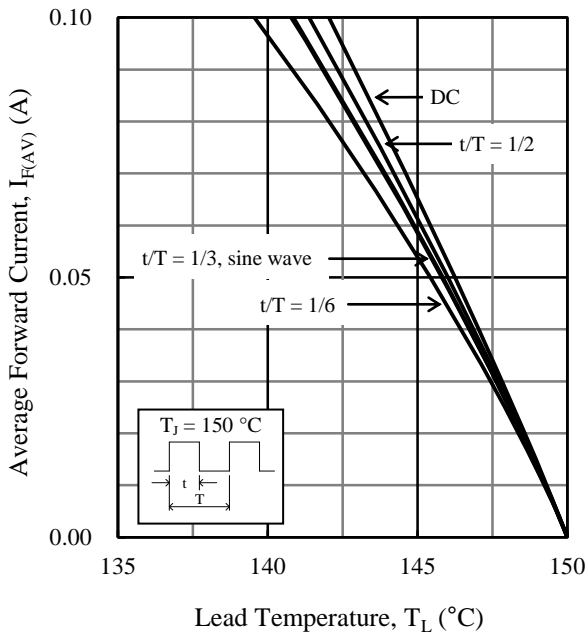


Figure 2.  $I_{F(AV)}$  vs.  $T_L$  Typical Characteristics<sup>(2)</sup>  
( $V_R = 0$  V)

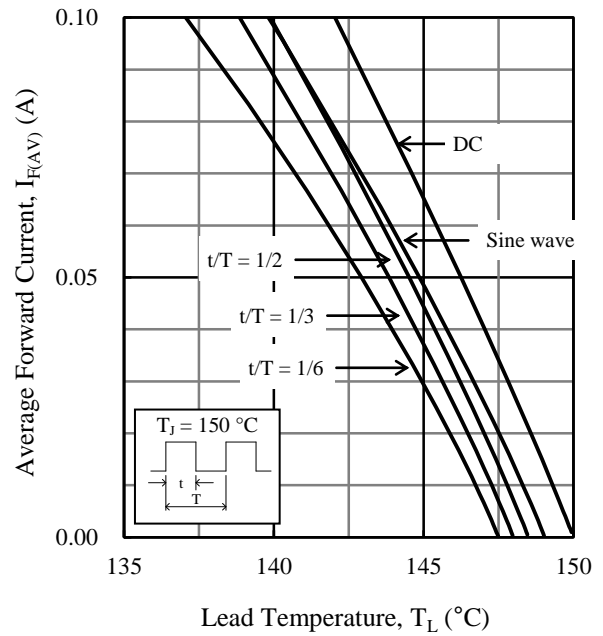


Figure 3.  $I_{F(AV)}$  vs.  $T_L$  Typical Characteristics<sup>(2)</sup>  
( $V_R = 2000$  V)

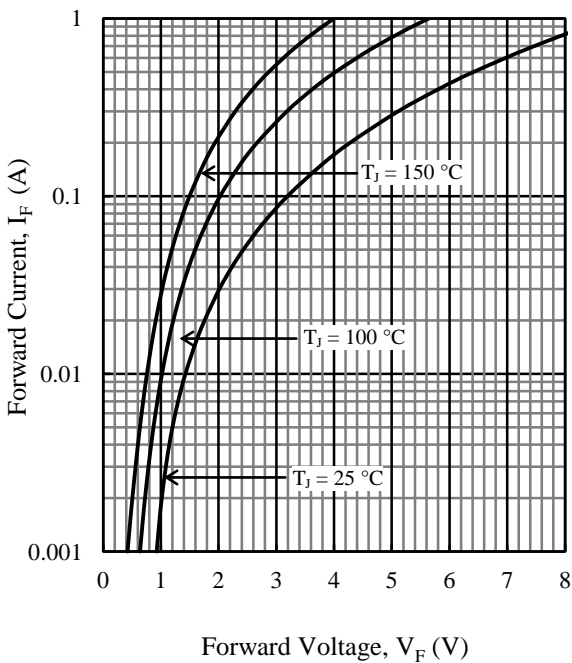


Figure 4.  $V_F$  vs.  $I_F$  Typical Characteristics

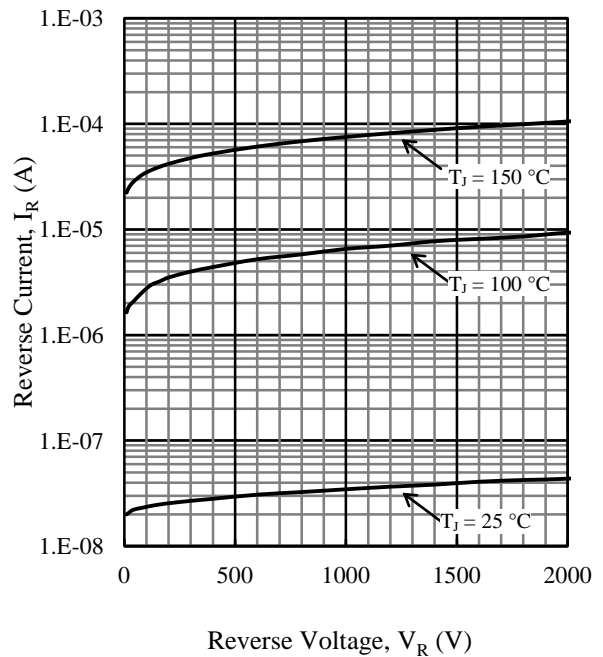


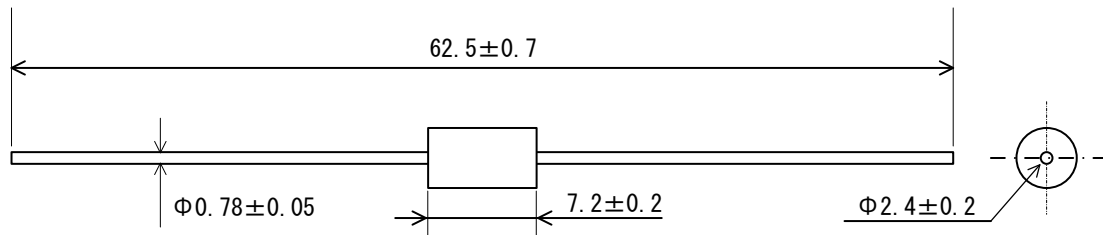
Figure 5.  $V_R$  vs.  $I_R$  Typical Characteristics

<sup>(2)</sup> See Figure 1 for the lead temperature measurement conditions.

# RP1H

## Physical Dimensions

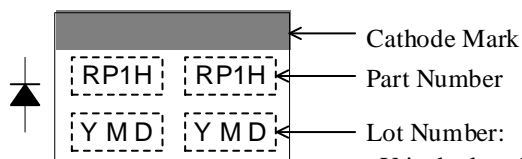
- Axial ( $\phi 4 \times 7.2L / \phi 0.78$ )



### NOTES:

- Dimensions in millimeters
- Bare leads: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time, within the following limits:
  - Flow:  $260 \pm 5$  °C /  $10 \pm 1$  s, 2 times
  - Soldering Iron:  $380 \pm 10$  °C /  $3.5 \pm 0.5$  s, 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the product.)

## Marking Diagram



Y is the last digit of the year of manufacture (0 to 9)

M is the month of the year (1 to 9, O, N or D)

D is the period of days represented by:

- : the first 10 days of the month (1st to 10th)
- : the second 10 days of the month (11th to 20th)
- : the last 10–11 days of the month (21st to 31st)

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